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October 2014

FDMS86252 N-Channel Shielded Gate PowerTrench[®] MOSFET

FDMS86252

N-Channel Shielded Gate PowerTrench[®] MOSFET 150 V, 16 A, 51 m Ω

Features

- Shielded Gate MOSFET Technology
- Max $r_{DS(on)} = 51 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 4.6 \text{ A}$
- Max $r_{DS(on)} = 70 \text{ m}\Omega \text{ at } V_{GS} = 6 \text{ V}, I_D = 3.9 \text{ A}$
- Advanced package and silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

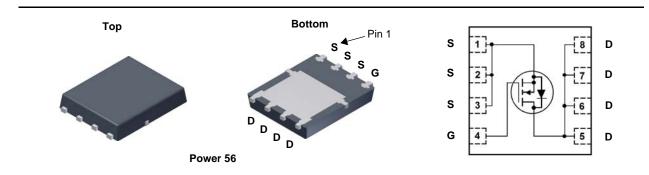


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

Application

DC-DC Conversion



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parame	eter		Ratings	Units	
V _{DS}	Drain to Source Voltage			150	V	
V _{GS}	Gate to Source Voltage			±20	V	
I _D	Drain Current -Continuous	T _C = 25 °C		16		
	-Continuous	T _A = 25 °C	(Note 1a)	4.6	Α	
	-Pulsed			20		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	50	mJ	
P _D	Power Dissipation $T_{C} = 25 \text{ °C}$			69	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

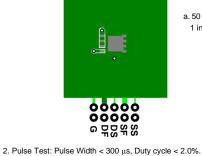
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.8	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/vv

Package Marking and Ordering Information

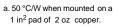
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86252	FDMS86252	Power 56	13 "	12 mm	3000 units

FDMS86252 N-C
hannel (
Shielded
N-Channel Shielded Gate PowerTrench [®] I
rTrench [®]
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150			V
$\frac{\Delta BV_{DSS}}{\Delta T_{1}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		106		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
	cteristics			+		
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	2.8	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C	2.0	-9	-1.0	mV/°C
4.1		V _{GS} = 10 V, I _D = 4.6 A		43.9	51	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 3.9 A$	50.5 70 83 96		70	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 4.6 \text{ A},$ T _J = 125 °C			96	
9 _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, I_D = 4.6 \text{ A}$		15		S
_	Output Capacitance Reverse Transfer Capacitance Gate Resistance	f = 1 MHz	0.1	74 4.3 0.4	115 10 1.8	pF pF Ω
C _{rss}	Reverse Transfer Capacitance			-		
R _g			0.1	0.1	1.0	
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			7.7	16	ns
t _r	Rise Time	V _{DD} = 75 V, I _D = 4.6 A,		2.3	10	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		15	27	ns
t _f	Fall Time			3.2	10	ns
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		11	15	nC
Q _q	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 75 V$,		6.1	8.6	nC
9	Gate to Source Charge	I _D = 4.6 A		2.8		nC
Q _{gs}	Gate to Drain "Miller" Charge			2.4		nC
Q _{gs}						
Q _{gs} Q _{gd}	arce Diode Characteristics			0.75	1.2	V
Q _{gs} Q _{gd} Drain-Sou	urce Diode Characteristics	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.00	1.3	- V
Q _{gs} Q _{gd}	Source-Drain Diode Forward Voltage	$V_{GS} = 0 \ V, \ I_S = 2 \ A \qquad (Note \ 2)$ $V_{GS} = 0 \ V, \ I_S = 4.6 \ A \qquad (Note \ 2)$		0.80	1.5	
Q _{gs} Q _{gd} Drain-Sou				0.80 56	90	ns

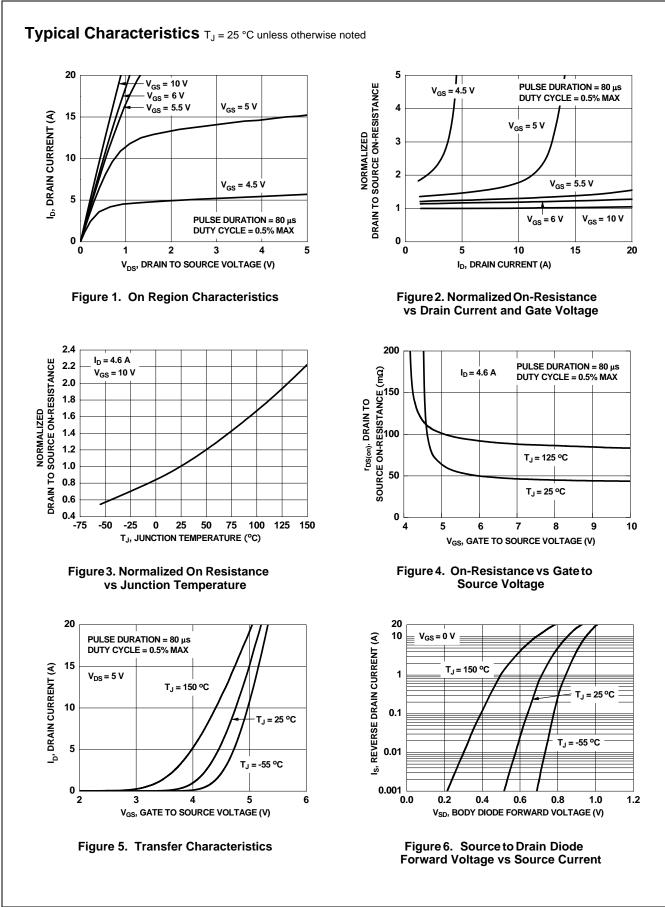


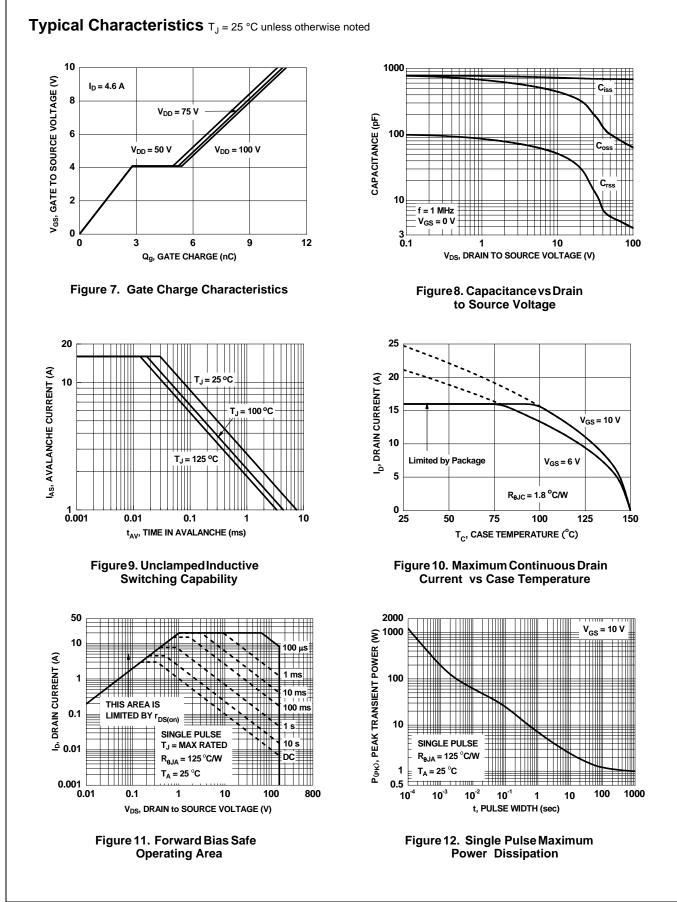
3. Starting T_J = 25 °C, L = 1 mH, I_{AS} = 10 A, V_{DD} = 135 V, V_{GS} = 10 V.

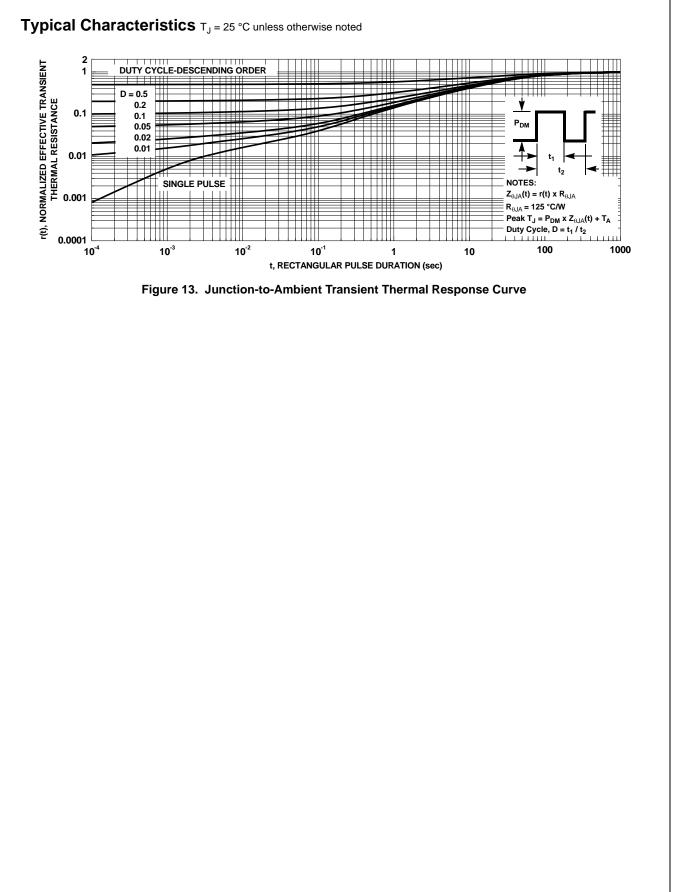


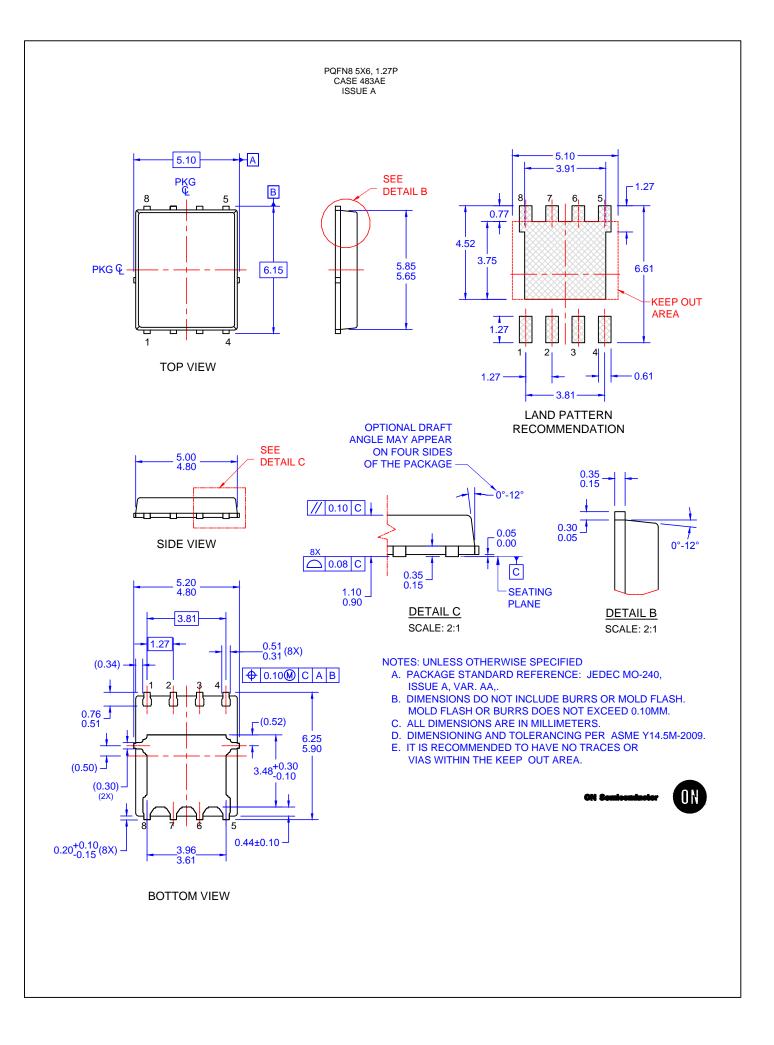


b. 125 °C/W when mounted on a minimum pad of 2 oz copper.









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